

Space degradation of 3J solar cells: I-Proton irradiation

Seonyong Park, Jacques C. Bourgoin, Hyeonseok Sim, Carsten Baur, Victor Khorenko, Olivier Cavani, Jérôme Bourcois, Sandrine Picard, Bruno Boizot

▶ To cite this version:

Seonyong Park, Jacques C. Bourgoin, Hyeonseok Sim, Carsten Baur, Victor Khorenko, et al.. Space degradation of 3J solar cells: I-Proton irradiation. Prog.Photovol.Res.Appl., 2018, 26 (10), pp.778-788. 10.1002/pip.3016 . hal-01960379

HAL Id: hal-01960379 https://hal.science/hal-01960379v1

Submitted on 2 Jan 2019

HAL is a multi-disciplinary open access archive for the deposit and dissemination of scientific research documents, whether they are published or not. The documents may come from teaching and research institutions in France or abroad, or from public or private research centers. L'archive ouverte pluridisciplinaire **HAL**, est destinée au dépôt et à la diffusion de documents scientifiques de niveau recherche, publiés ou non, émanant des établissements d'enseignement et de recherche français ou étrangers, des laboratoires publics ou privés.

Space degradation of 3J solar cells: I-Proton irradiation

Seonyong Park¹, Jacques C. Bourgoin¹, Hyeonseok Sim¹, Carsten Baur³, Victor Khorenko⁴, Olivier Cavani¹, Jérôme Bourcois², Sandrine Picard², Bruno Boizot¹

1 Laboratoire des Solides Irradiés, CNRS-UMR 7642, CEA-DRF-IRAMIS, Ecole Polytechnique, Université Paris-Saclay, Palaiseau Cedex 91120, France

2 CSNSM, Université Paris-Sud, CNRS/IN2P3, Université Paris-Saclay, 91405 Orsay, France

3 European Space Agency, Keplerlaan 1, 2201AZ Noordwijk, The Netherlands

4 AZUR SPACE Solar Power GmbH, Theresienstr. 2, 74072 Heilbronn, Germany

To understand the influence of proton irradiation on lattice-matched GalnP/GaAs/Ge triple junction (TJ) solar cells under low intensity, low temperature (LILT) conditions, we investigated electrical behaviors of top, middle, and bottom component cells together with TJ cells under these conditions. Proton irradiations with energies of 1 MeV and fluences ranging from 2×10^{10} to 1.6×10^{12} cm⁻² were performed at temperatures ranging from 100 to 300 K. Our study reveals that any of the 3 subcells can become the current limiting cell in the TJ cell, depending on temperature and fluence. In particular, remarkable degradation of the bottom cell at low temperature can make this subcell the current limiting in a TJ cell even for limited fluences. The results indicate that the defect distribution is non-uniform for low temperature irradiation.

Funding information

EMIR federation, Grant/Award Numbers: 15-5727 and 4000109645; European Space Agency

1 | INTRODUCTION

State-of-the-art solar cells used for space missions are lattice-matched triple junction (TJ) cells, composed of GalnP, GaAs, and Ge-based subcells monolithically connected in series, because they demonstrate the highest efficiency so far.^{1,2} Moreover, they exhibit the best radiation resistance compared to other types of cells.^{3,4} Their behavior under electron and proton irradiations at room temperature has been studied extensively.⁵⁻¹¹

These TJ cells are also now used for interplanetary and deep space missions, whose typical environment is often referred to as LILT (for low intensity, low temperature) conditions. However, the understanding of their behavior under particle irradiation at low temperature is still in infancy. Because of the difficulty to perform irradiation testing at low temperature followed by in-situ electrical data acquisition under solar illumination, this understanding has been deduced from low temperature measurements performed after room temperature irradiation.¹²⁻¹⁴ With the exception of 1 attempt,^{15,16} the only studies of low temperature irradiation with in-situ measurements have been performed on TJ cells produced by AZUR SPACE.¹⁷⁻²⁰

Preliminary results¹⁷ suggested that the electrical behavior of these TJ cells at low temperature was independent from the

temperature at which irradiations were performed. However, detailed analysis of the data acquired at low temperature reveals that several phenomena such as defect annealing, junction behavior under stress, and tunneling have to be taken into account, the phenomena which are not observable in case of room temperature irradiation. This motivated us to perform a detailed study of the degradation of TJ cells and their respective component cells at temperatures ranging from 100 to 300 K. The study presented here is limited to the case of proton irradiation; the case of electron irradiation will be presented in a dedicated publication.²¹

2 | EXPERIMENTAL

The realization of low temperature current-voltage (I-V) measurements of solar cells irradiated at low temperature requires a cryostat setup allowing to position the cell perpendicular to the irradiating beam of the proton accelerator and then to the illumination source. The vacuum (10^{-7} mbar) must be the same in the cryostat and the accelerator because even a thin foil of separation would absorb incoming protons. Thus, all measurements are also performed in the same vacuum condition as that of the proton irradiation. Our cryostat setup consists of a chamber equipped with a vacuum flange for mounting to the beam line, a quartz window for the illumination, the cell support designed for a cell size of $2 \times 2 \text{ cm}^2$, temperature sensors, and electrical wiring for performing electrical measurements. Cooling and temperature stabilization are realized by a liquid nitrogen flow and an ohmic heater which is incorporated into the support. This support is made of pure copper to allow good thermal conduction at low temperature. The temperature is monitored with a temperature controller (from Lakeshore). Temperatures in the range 80 to 400 K can be achieved. Electrical measurements are conducted using a (Keithley) sourcemeter.

As the temperature decreases, the temperature difference between the support and the cell increases. It is necessary, therefore, to measure directly the temperature of the cell using a calibrated sensor. For this purpose, a CERNOX temperature sensor, soldered on the surface of a dummy cell, is used to establish the relationship between the temperatures of the support and of the cell. The reported temperatures here are the ones delivered by the CERNOX sensor.

The solar simulator delivering the illumination has been originally realized, together with the cryostat, to perform tests on the Si solar cells designed for the Rosetta mission.²²⁻²⁴ It has been continuously improved since. It consists of a Xenon (Xe) lamp coupled to a Quartz Tungsten Halogen lamp through a cold filter which eliminates the low energy part of the Xe and the high energy part of the Quartz Tungsten Halogen. Calibration of the simulator is performed by adjusting the intensities of the 2 lamps using corresponding GalnP (top), GaAs (middle), and Ge (bottom) component cells, ie, single-junction cells having the same structure as the TJ cell but with only 1 junction being electrically active, as illustrated in Figure 1. In this study, we adapted the simulator to the Jupiter relevant conditions which are 3.7% AMO. The spectrum of the solar simulator is recorded using a low-resolution spectrometer (a prism, in order to integrate the Xe peaks) equipped with a lock-in amplifier and a Ge detector (see Figure 2).

The aperture of the proton beam is 8 cm² (covering the whole area of the cell). The proton energy used is 1 MeV with a flux of 4 × 10⁹ cm⁻² s⁻¹ and fluences ranging from 2 × 10¹⁰ cm⁻² to 1.6 × 10¹² cm⁻². A SRIM simulation of the TJ structure of Ga_{0.51}In_{0.49}P (0.6 μ m)/GaAs (2.6 μ m)/Ge (140 μ m) has been carried out (see Figure 3) using the SRIM-2013 software developed by James F. Ziegler.²⁵ A depth profile of the proton energy loss is plotted up to



FIGURE 2 AMO solar simulator spectrum monitored with a Ge detector [Colour figure can be viewed at wileyonlinelibrary.com]

8 μm from the surface of the top cell. The energy of incident proton was set to 1 MeV, and the threshold energy for displacement (T_D) was assumed as 21 eV for the 3 materials. The average energy loss (E_{Loss}) of the protons in junctions of each layer is between 5 and 7 eV/Angstrom. According to the SRIM coding, protons that have 1-MeV energy are stopped within the depth of 11.5 μm , sufficiently far from the active region of Ge bottom cell.

3 | RESULTS

3.1 | Irradiation of TJ cells at low temperature.

TJ cells were irradiated by 1-MeV protons with fluences varying from 1×10^{11} to 5.4×10^{11} cm⁻². Irradiations and measurements were performed at 123 K. The number of cells irradiated in each condition varied from 3 to 13. Relative changes of I_{SC}, V_{OC}, and P_{MAX} values after irradiation expressed, as remaining factor (RF), are presented in Figure 4. The change of RF (I_{SC}) versus fluence is small below typically 2.7×10^{11} cm⁻², whereas it suddenly increases reaching 0.93 at 5.4×10^{11} cm⁻². This observation suggests that there could be a critical condition corresponding to a modification of the degradation mechanism (a change of the subcell which limits the current). As to



FIGURE 1 Description of the triple junction and component cells used in this study [Colour figure can be viewed at wileyonlinelibrary.com]



FIGURE 3 SRIM simulation with 1 MeV proton irradiation on the TJ cell used in this study. A, Profile of ion propagation, B, ionization energy loss versus target depth, and C, ion ranges. Displacement energy (T_D) of 21 eV is applied for 3 materials [Colour figure can be viewed at wileyonlinelibrary.com]



FIGURE 5 Fluence dependences of A, I_{SC} and B, V_{OC} of component cells at 100, 123, 200, and 300 K irradiated at 1 MeV with a flux of $4x10^{\circ}$ cm⁻² s⁻¹. Black square, red circle, and blue triangle indicate top, middle, and bottom component cells, respectively [Colour figure can be viewed at wileyonlinelibrary.com]

RF (V_{OC}), it decreases regularly as a function of fluence, after an initial step for the lowest fluence used. However, RF (P_{MAX}) decreases more rapidly than the product $I_{SC} \times V_{OC}$, as it should vary if the fill factor (FF) was independent of the fluence. At the highest fluence, RF (P_{MAX}) is approximately 0.77 suggesting that there seems to be another source of degradation, besides I_{SC} and V_{OC} , affecting the FF.

3.2 | Irradiation of component cells at various temperatures

The investigation of component cells was performed to determine the changes of the key parameters associated with each cell as a function of fluence in the temperature range 100 to 300 K. Here, we focus on the changes of I_{SC} and V_{OC} .

Accumulative irradiations were carried out on top, middle, and bottom component cells at 100, 123, 200, and 300 K. Figure 5A shows the changes of I_{SC} as a function of fluence. The top cell appears to exhibit a smaller degradation than the middle cell. At room temperature, because BOL ISC values of a top cell are slightly smaller than that of the middle cell, the top cell is actually the current limiting cell in the TJ cell. However, the middle cell becomes the current limiting cell after irradiation with a fluence of approximately 10¹¹ cm⁻² because its degradation is stronger than that of the top cell. For lower temperatures, the cells act differently: when the temperature decreases, ISC of the top cell decreases while that of the middle cell apparently increases. As a result, a higher fluence (5 \times 10¹¹ cm⁻²) is required to make I_{SC} of the middle cell lower than that of the top cell. The bottom cell has a much higher BOL Isc value compared to other 2 cells, so that, at 200 and 300 K, in the TJ cell, the bottom cell does not become the current limiting cell even at high fluences. However, at 123 and 100 K, the value of I_{SC} of the bottom cell decreases abruptly: the large drop of I_{SC} occurs for a very small fluence (2 × 10¹⁰ cm⁻²), partly at least because of the photon recycling effect, PRE²⁶ (an effect not present in the TJ cell), as we shall see below. Thus, the bottom cell will become current limiting in the TJ cell. As to the V_{OC} degradations of the 3 component cells, they are presented in Figure 5B.

Because the degradation of the bottom component cell appears to depend strongly on the irradiation temperature, we performed additional irradiations of these cells. The results are shown in Figure 6. Once corrected to remove the contribution of the PRE, they show that RF (I_{SC}) is strongly temperature dependent (see Figure 7). The contribution of the PRE is deduced from the difference of I_{SC} of the bottom cell between a non-irradiated cell and a cell irradiated with a fluence of 2 × 10¹⁰ cm⁻² (known to cancel photon recycling while introducing a negligible degradation). Figure 8 shows the contribution of PRE versus temperature, difference of I_{SC} between non-irradiated and irradiated bottom cells.

The comparison between the degradations of I_{SC} and V_{OC} of the TJ cells with that deduced from the degradation of component cells (by selecting the minimum value of I_{SC} among the component cells and adding their V_{OC} values) is given in Figure 9. It shows that for V_{OC} reasonable fits are obtained, which implies that the prediction of the V_{OC} degradation of TJ cells can be reasonably well deduced from that of the component cells. For the I_{SC} degradation, the fits at low temperature are not satisfying because of the low shunt resistance of the



FIGURE 6 I_{SC} remaining factor of bottom component cells irradiated at various temperatures with a flux of 4×10^9 cm⁻² s⁻¹ (the results are not corrected for PRE) [Colour figure can be viewed at wileyonlinelibrary.com]



FIGURE 7 I_{SC} remaining factor of bottom component cells irradiated with 1 MeV protons at 100, 123, 150, 200, and 250 K after correction for PRE. Nonlinear curve fit is applied for each temperature [Colour figure can be viewed at wileyonlinelibrary.com]



FIGURE 8 BOL (black square) and EOL (red circle) I_{SC} of bottom component cells versus temperature after 1-MeV irradiation with a fluence of 2×10^{11} cm⁻² and annealing at 300 K, illustrating the contribution of the photon recycling effect [Colour figure can be viewed at wileyonlinelibrary.com]



FIGURE 9 Comparison of the degradations of TJ cells with that deduced from the degradation of component cells: A, I_{SC} and B, V_{OC} at 100, 123, 200, and 300 K: Black circle and red star indicate data obtained from component cells and TJ cells, respectively [Colour figure can be viewed at wileyonlinelibrary.com]

bottom cell. In those cases, where the bottom cell would be the current limiting cell (according to Figure 3A), the bottom cell in the 3J cell is driven in reverse at 0 V. Then, when the I-V curve has a steep slope (due to the low shunt resistance), the I_{SC} of the triple-junction cell is higher compared to the single bottom component cell. Mostly, the current limiting cell at 0 V is then even 1 of the other 2 subcells.

3.3 | Isochronal annealing in component cells

Because the component cells exhibit different temperature dependent behaviors, we performed isochronal annealing procedures following irradiation with a fluence of 1.6×10^{12} cm⁻² at 100 K. Figure 10A shows the RFs of I_{SC}, V_{OC}, and P_{MAX} of the 3 component cells measured at 100 K after each annealing step. The annealing was carried out at 150, 190, 240, and 300 K during 5 minutes for the top and middle cells. For the bottom cell, the annealing temperature was increased by 18 K after the previous step. The annealing time was 5 minutes as well (see Figure 10B,C). The top and middle cells did not show any significant recovery throughout the temperature range 100 to 300 K. However, changes of I_{SC} and V_{OC} values of the bottom cell result in a recovery of RF (P_{MAX}) from 0.25 to 0.41, with 2 stages centered around 125 and 250 K.

3.4 | Electrical characteristics of irradiated cells at low temperature

Besides usual degradations of I_{SC} and V_{OC} , TJ cells exhibit, in addition to the degradation induced by minority carrier recombination induced

by the defects, a degradation associated with another cell parameter, which is only observable under illumination. Figure 11 shows the comparison between I-V characteristics under illumination (LIV) and in dark (DIV) after irradiation with a fluence of 1.6×10^{12} cm⁻². The DIV curve is shifted by I_{SC}, so that the DIV and LIV curves exhibit the same current at V = 0. Before irradiation, these 2 curves overlap perfectly. However, after irradiation, the current under illumination starts to increase as a function of voltage while the dark current maintains its original value. This phenomenon results in a significant decrease of FF after irradiation, as noticed in the Section 3.1.

The same experiment has also been carried for all 3 component cells. As shown in Figure 12, only at EOL condition, we observe a discrepancy between LIV and shifted DIV curves for the top and middle cells. Within measurement accuracy, this effect is not observed for the bottom cell. Hence, the decrease of the photo current under illumination as a function of voltage in a TJ cell originates at least from the top and (or) middle subcells.

4 | DISCUSSION AND ANALYSIS

4.1 | Temperature and fluence dependences of the degradation

As shown in Figure 5A, in BOL condition, the 3 component cells behave differently as a function of temperature. The I_{SC} values of top component cell decrease gradually from approximately 2.42 to 2.05 mA as the temperature goes down from 300 to 100 K. As briefly



FIGURE 10 A, Remaining factors of I_{SC} , V_{OC} , and P_{MAX} of proton irradiated (1 MeV, 1.6×10^{12} cm⁻²) component cells during isochronal annealing stages: Black square—Top, red circle—Middle, blue triangle—Bottom cells, respectively. Temperature profiles of isochronal annealing stages are represented for B, top and middle cells and C, bottom cell [Colour figure can be viewed at wileyonlinelibrary.com]



FIGURE 11 BOL (inset) and EOL I-V characteristics of a TJ cell irradiated with 1.6×10^{12} cm⁻² at 123 K (black line: dark I-V, red line: dark I-V + I_{SC} (EOL), blue line: light I-V) [Colour figure can be viewed at wileyonlinelibrary.com]

explained in Section 3.2, the temperature behavior is not gradual: I_{SC} of the middle cell decreases from 300 to 200 K and increases again from 200 to 100 K; in the bottom cell, this transition occurs around 150 K. This behavior is due to the existence of the temperature dependent PRE in these cells (this is the reason why it is different in single cells²⁷).

The rates of degradation of the components cells are different and depend on the temperature. Consider the I_{SC} values: the top cell exhibits a small degradation below 10^{12} cm⁻²; the middle cell exhibits a significant degradation from the lowest fluence: around 20% at 300 and 200 K, increasing to approximately 50%, at 100 K. As to the bottom cell, the sharp drop for the lowest fluence at low temperature must correspond partially to the cancellation of PRE, which is known to disappear after irradiation with the lowest fluence (see Figure 8). However, as we shall now examine, the change of I_{SC} in this cell is strongly temperature dependent, apparently more than expected when taking defect annealing into account. Note in particular, that at 300 K, I_{SC} decreases by approximately 1 mA when the fluence increases from 1×10^{11} to 1.6×10^{12} cm⁻². This result is apparently surprising because it is in contradiction with results of electron irradiation at 300 K: no change of I_{SC} is then observed²¹ in identical bottom cells irradiated with 1-MeV electrons for fluences ranging from 5×10^{14} to 2×10^{15} cm⁻². Using SR-NIEL Calculator,²⁸ the NIEL values of 1 MeV proton and electron in Ge (assuming that T_D is 21 eV) are obtained as 4.9×10^{-2} and 1.1×10^{-5} MeVcm²/g, respectively. Therefore, the calculated displacement damage doses are approximately 4.9×10^9 to 7.8×10^{10} MeV/g for protons and 5.5×10^9 to 2.2×10^{10} MeV/g for electrons, respectively.

We therefore performed a systematic study of I_{SC} versus fluence and temperature to investigate the mechanism of degradation in the bottom cell. The results are shown in Figure 13 under the form C = 1 - RF(I_{SC}), a quantity which reflects directly the concentration of defects introduced by the irradiation versus temperature with several fluences.

This figure illustrates that C varies regularly with temperature, a behavior not expected, if it is the result of defect $annealing^{29}$: the amplitude of the annealing stage around 125 K observed in the isochronal annealing procedure (see Figure 10), of the order of 0.1, is not observed in the figure.

On the other hand, the temperature dependence of the fluence (Figure 14) required to reach a given degradation level and hence, a given defect concentration, changes over nearly 2 orders of magnitude between 150 and 250 K, while it is not significantly changed between 100 and 150 K, which is also not compatible with defect introduction.



FIGURE 12 BOL (inset) and EOL I-V characteristics of top, middle, and bottom component cells irradiated at 123 K with 8×10^{11} cm⁻² (black line: dark I-V, red line: dark I-V + I_{SC} (EOL), blue line: light I-V) [Colour figure can be viewed at wileyonlinelibrary.com]



FIGURE 13 1 – RF (I_{SC}) versus temperature in bottom component cells irradiated with various fluences (cm⁻²) [Colour figure can be viewed at wileyonlinelibrary.com]

That electron irradiation at 300 K does not produce any degradation is consistent with results of old studies where no defects were detected in p-type Ge,²⁹ material with which the cells are produced (by As diffusion). This is understood by the mobility of the primary defects, interstitials, and vacancies (V-I pairs), which recombine already at 4 K.²⁹ In the case of proton irradiation, the situation is quite different: the V-I pairs are not uniformly distributed but decorate the proton tracks; they are hence in large, local, concentration and instead of recombining, they form complexes (such as divacancies) which are stable. These complexes being charged produce space charge regions of cylindrical shape along the tracks which repel the photocarriers.

Hence, the degradation in the bottom cell, at least at low temperature, is not the result of minority carrier recombination on defects but corresponds to the decrease of the effective cell area.

As shown in Figure 15, when the bottom component cell is irradiated with protons, one can see that there is no increase of the saturation current. This indicates that no defects are introduced in the active area of the cell.



FIGURE 14 Logarithm of the fluence versus temperature for $RF(I_{SC}) = 0.8$ of bottom component cells. Data points were obtained from the nonlinear curve fit of Figure 5 at each temperature

The degradation model is therefore the following: an incoming proton produces atomic displacements, ie, defects, along its track. Some of these defects are charged and consequently create a space



FIGURE 15 Dark I-V characteristics of a bottom component cell at 100 K irradiated with various fluences (cm⁻²) [Colour figure can be viewed at wileyonlinelibrary.com]

charge region which can be approximated by a cylindrical volume V of radius r, perpendicular to the surface of the cell. The radius r is a function of the charge Q trapped on the defects and of the doping concentration N in the material. Equality between the charge Q and the opposite charge NV developed in the space charge region makes that r is a function of Q and N at a given temperature.

The space charge regions decorating the proton tracks repel the minority carriers generated by the illumination and, thus, reduce the effective active area *S* of the cell. Under the introduction of ϕ protons (per unit surface):

$$S = S_0 - \varphi S_0 \pi r^2$$

where S_0 the cell area, so that S can be expressed by

$$\frac{S}{S_0} = 1 - \varphi \pi r^2.$$

The photocurrent being proportional to the active area of the cell degrades at the rate S/S_0 such that

$$1\text{-}RF(\textit{lsc}) = 1\text{-}\frac{S}{S_0} = \phi\pi r^2.$$

The temperature dependence of $RF(I_{SC})$ should reflect that of r^2 which can be approximated by the fact that the carriers (of energy kT) are repelled by the potential of the charge Q (proportional to r^{-1}). Thus, $RF(I_{SC})$ should (to first order) vary linearly with T^{-2} . Figure 16 illustrates that this is approximately the case when the temperature is large enough.

Finally, according to this picture, the degradation of V_{OC} is expected, as observed, to be small because it is not dependent on the cell area.

In conclusion, the experimental data concerning the bottom cell indicate that the degradation induced by proton irradiation at low temperature in Ge is governed by space charged regions located around proton tracks, which implies that the resulting distribution of the induced defects is not uniform.

The bottom cell appears to become the current limiting cell below 123 K for a fluence larger than approximately 10 ¹¹ cm⁻². Prediction of the nature of the current limiting cell versus temperature is not



FIGURE 16 $RF(I_{SC})$ versus T^{-2} of bottom component cells irradiated with various fluences (cm⁻²) [Colour figure can be viewed at wileyonlinelibrary.com]

easy. In BOL triple-junction lattice matched cells, at 300 K and below, the top subcell is current limiting. Proton irradiation significantly degrades the I_{SC} of middle and bottom subcells resulting in the change of current limiting cell from top to middle or from top to bottom cell, depending on the temperature. The diagram of Figure 17 is an attempt to illustrate the expected temperature and proton fluence conditions indicating the nature of the limiting cell (note that Figure 17 necessitates considerably more data to be accurate).

4.2 | Annealing

The results describing the RFs of I_{SC} , V_{OC} , and P_{MAX} following isochronal steps are given in Figure 10. From the variations of I_{SC} , it can be concluded that no significant defect annealing occurs in top and middle subcells in the range 100 to 300 K. Defects in top cells irradiated with protons below 300 K have not been previously investigated; only preliminary results exist for electron irradiations.³⁰⁻³⁴ As shown in Figure 5, at 100 K, decreases of 4% of I_{SC} and few % of V_{OC} occur after the proton irradiation with a fluence of 1.6×10^{12} cm⁻². As to the middle subcell, the conclusion is consistent with previous studies on electron induced defects in GaAs^{35:} it has been established that in GaAs electron induced defects created at 4 K remain stable up to room temperature: no annealing stage should take place between 100 and 300 K. As to bottom cells, the annealing stages we observed could correspond to the defects detected following low temperature electron irradiation.²⁹

4.3 | Electric field dependence of defect recombination

Besides the degradation induced by recombination of carriers generated by the illumination on the traps associated with the created defects, another type of degradation is observed, associated with the decrease of the photocurrent with increasing forward bias (see Figures 11 and 12). As demonstrated in Figure 12, this effect occurs



FIGURE 17 Fluence-temperature diagram indicating the regions in which a sub- cell is limiting the TJ cell: circle and cross symbols indicate transition points of current limiting from top to bottom and from top to middle subcell, respectively [Colour figure can be viewed at wileyonlinelibrary.com]

only in the top and middle subcells, in agreement with the fact that no defects are created in the active region of the bottom cell.

We understand this phenomenon as being related to the effect of electric field on the capture rate of free carriers by defects, a consequence of the increase of the capture rate of carriers on the defects via the Poole-Frenkel effect.³⁶ In other words, the photo-generated carrier has an enough kinetic energy to resist the coulombic attraction of a trap (defect site) induced by the irradiation when no external bias is applied (V = 0 V). On the other hand, in positive biased conditions (V > 0 V), the carrier contains less kinetic energy compared to the zero bias condition (see Figure 18A,B). Therefore, the capture cross section

of a minority carrier on a defect site, which results in carrier recombination and thus governs the collected photocurrent, depends on the electric field in the junction, ie, on the applied voltage. This phenomenon, which has been treated rigorously,³⁷ can be illustrated schematically in the following way: free carriers in a depletion region have an energy which depends on temperature and electric field; they are captured by a defect when their energy becomes smaller than the attractive defect potential as illustrated in Figure 18C. For a Coulomb potential, the capture cross section varies as V⁻² so that the trap assisted recombination current I_{tr} increases with V. Similarly, when the higher bias is applied, the effective width of space charge region



FIGURE 18 Simplified description of the electric field dependence of trap assisted recombination current (I_{tr})-band diagram A, without bias, B, positive bias, and C, a simple diagram of the electric field dependent capture rate of carriers on defects [Colour figure can be viewed at wileyonlinelibrary.com]



FIGURE 19 Voltage dependence of I_{tr} of top (left) and middle (right) component cells irradiated at 123 and 300 K (inset) for different fluences [Colour figure can be viewed at wileyonlinelibrary.com]

is shortened, which probably makes some of traps being located in the flat region and then becoming active for recombination.

The variation of trap assisted recombination current (I_{tr}) as a function of V can be extracted from Figure 10 by subtracting a shifted DIV curve ($I_{Dark} + I_{SC}$) from LIV one (I_{Light}). We can evaluate the degradation factor induced by I_{tr} at the point where the power is maximum. The effects of irradiation fluence and temperature are shown in Figure 19. Apparently, the amount of I_{tr} depends on the fluence and the effects become smaller as the temperature increases. In the case of irradiation with a fluence of 8×10^{11} cm⁻², P_{MAX} predicted from the shifted DIV curve and measured from the LIV curve are approximately 3.00 and 2.71 mW for the top component cell, and 1.98 and 1.79 mW for the middle cell. Therefore, the degradation factor of the P_{MAX} due to this effect is approximately 9.7% for the top cell and 9.6% for the middle cell, respectively.

This electric field effect is only observed in top and middle cells. It is not present in bottom cells because the irradiation induced defects are located in regions (cylinders around proton tracks) which do not participate to the active part of the cell.

5 | CONCLUSION

We irradiated TJ cells and associated component cells with various fluences of 1-MeV protons in the range 300 to 100 K. We verified that the I-V characteristics of the component cells are consistent with the reconstruction of the characteristics of the TJ cell, and consequently that the electrical properties of a TJ cell can be deduced from that of the component cells. The degradation of the current induced by the irradiation is due to the introduction of recombination centers but also, at low temperature, to the degradation of the FF as a result of the electric field dependence of the capture rates of minority carriers on the defects. The high degradation of the current in the bottom (Ge) cell can result in the TJ cell becoming bottom cell limited in certain EOL LILT conditions. It is the consequence of the fact that the distribution of the defects is not uniform, because they are decorating the proton tracks. The result is the formation of space charge regions, repelling free carriers and the degradation is primarily due to the reduction in the active area of the cell. This explanation allows to understand the peculiar difference observed between electron and proton irradiations performed on the same cells^{38:} a tunneling current is induced in electron irradiated cells (in which the defects are uniformly distributed), but not in proton irradiated ones (in which the defects are located in space charge regions, thus reducing the active area of the cell).

ACKNOWLEDGEMENTS

The present work is supported by the European Space Agency under contract no. 4000109645. The irradiation has been performed in ARAMIS of SCALP facility of Centre de Sciences Nucléaires et de Sciences de la Matière and supported by EMIR federation (EMIR project no. 15-5727).

ORCID

Seonyong Park 🗅 http://orcid.org/0000-0001-9714-207X

Bruno Boizot D http://orcid.org/0000-0002-4613-9468

REFERENCE

- Bett AW, Dimroth F, Guter W, Hoheisel R, Oliva E. Highest efficiency multi-junction solar cell for terrestrial and space applications. 24th European Photovoltaic Solar Energy Conference (EUPVSEC). September 2009.
- Green MA, Emery K, Hishikawa Y, Warta W, Dunlop ED. Solar cell efficiency tables (version 45). Prog Photovolt Res Appl. 2014;23(1):1-9. https://doi.org/10.1002/pip.2573
- Yamaguchi M, Okuda T, Taylor SJ, Takamoto T, Ikeda E, Kurita H. Superior radiation-resistant properties of InGaP/GaAs tandem solar cells. *Appl Phys Lett.* 1997;70(12):1566-1568. https://doi.org/ 10.1063/1.118618
- Dharmarasu N, Yamaguchi M, Khan A, et al. High-radiation-resistant InGaP, InGaAsP, and InGaAs solar cells for multijunction solar cells. *Appl Phys Lett.* 2001;79(15):2399-2401. https://doi.org/10.1063/ 1.1409270
- Imaizumi M, Takamoto T, Sumita T. Study of radiation response on single-junction component sub-cells in triple-junction solar cells. 3rd World Conference on Photovoltaic Solar Energy Conversion 2003:599-602.
- Gauffier A, Gauffier A, David JP, Gilard O, David JP, Gilard O. Analytical model for multi-junction solar cells prediction in space environment. *Microelectron Reliab.* 2008;48(8–9):1494-1499. https://doi. org/10.1016/j.microrel.2008.07.049
- Rong W, Yunhong L, Xufang S. Effects of 0.28–2.80MeV proton irradiation on GalnP/GaAs/Ge triple-junction solar cells for space use. Nucl Instrum Methods Phys Res, Sect B. 2008;266(5):745-749. https://doi. org/10.1016/j.nimb.2007.12.076
- Sato S-I, Ohshima T, Imaizumi M. Modeling of degradation behavior of InGaP/GaAs/Ge triple-junction space solar cell exposed to charged particles. J Appl Phys. 2009;105(4):044504. https://doi.org/10.1063/ 1.3079522
- Elfiky D, Yamaguchi M, Sasaki T, et al. Study the effects of proton irradiation on GaAs/Ge solar cells. IEEE 35th Photovoltaic Specialists Conference (PVSC) 2010:002528-002532. doi:https://doi.org/ 10.1109/PVSC.2010.5614633.
- Xin G, Zhan-zu F, Xin-yu C, Sheng-sheng Y, Lei Z. Performance evaluation and prediction of single-junction and triple-junction GaAs solar cells induced by electron and proton irradiations. *IEEE Trans Nucl Sci.* 2014;61(4):1838-1842. https://doi.org/10.1109/TNS.2014.2306991
- Hoheisel R, Scheiman D, Messenger S, Jenkins P, Walters R. Detailed characterization of the radiation response of multijunction solar cells using electroluminescence measurements. *IEEE Trans Nucl Sci.* 2016;62(6):2894-2898. https://doi.org/10.1109/TNS.2015.2498838.
- Gelderloos CJ, Miller KB, Walters RJ, Summers GP, Messenger SR. Low intensity low temperature performance of advanced solar cells. IEEE 29th Photovoltaic Specialists Conference (PVSC) 2002:804–807. doi: https://doi.org/10.1109/pvsc.2002.1190695.
- Stella P, Davis G, Mueller R, Distefano S. The environmental performance at low intensity, low temperature (LILT) of high efficiency triple junction solar cells. *2nd International Energy Conversion* Engineering Conference 2004. doi:https://doi.org/10.2514/6.2004-5579.
- Stella PM, Mueller RL, Scrivner RL, Helizon RS. Preliminary low temperature electron irradiation of triple junction solar cells. 19th Space Photovoltaic Research and Dent Tech. 2007;1-7. https://ntrs.nasa.gov/ search.jsp?R=20090022291
- Ohshima T, Sumita T, Imaizumi M. Evaluation of the electrical characteristics of III-V compounds solar cells irradiated with protons at low temperature. IEEE 35th Photovoltaic Specialists Conference (PVSC). 2005:806–809. doi:https://doi.org/10.1109/PVSC.2005.1488255.
- 16. Harris RD, Imaizumi M, Walters RJ, et al. In situ irradiation and measurement of triple junction solar cells at low intensity, low

temperature (LILT) conditions. *IEEE Trans Nucl Sci.* 2008;55(6):3502-3507. https://doi.org/10.1109/TNS.2008.2006971

- Baur C, Khorenko V, Siefer G, et al. Development status of triplejunction solar cells optimized for low intensity low temperature applications. IEEE 39th Photovoltaic Specialists Conference (PVSC) 2013:3237–3242. doi:https://doi.org/10.1109/pvsc.2013.6745142.
- Bourgoin JC, Boizot B, Khirouni K, Khorenko V. On the prediction of solar cell degradation in space. 10th European Space Power Conference (ESPC) 2014;719:1.
- Taylor S, Baur C, Torunski T, et al. Performance of European Triple-Junction Solar Cells for Deep Space Missions 8th European Space Power Conference (ESPC) 2008;661:34–39.
- Baur C, Khorenko V, Siefer G, Inguimbert V, Park S, Boizot B, Bourgoin JC, Casale M, Campesato R, Schnell HG, Gerhard A, Zanella P, Ferrando E, Reutenauer X, Bongers E, Gras A Status of solar generator related technology development activities supporting the juice mission. Fernandez a, ed. E3S Web Conf. 2017;16(8):04005-04008. doi: https://doi.org/10.1051/e3sconf/20171604005.
- Park S, Bourgoin JC, Cavani O, Khorenko V, Baur C, Boizot B. Space degradation of 3J solar cells: II-electron irradiation. to be published.
- Nubile P, Nubile P, Bourgoin JC, Stievenard D, Deresmes D, Strobl G. Defects in low-temperature electron-irradiated p-type silicon. J Appl Phys. 1992;72(7):2673-2679. https://doi.org/10.1063/1.351516
- Zazoui M, Zaidi MA, Bourgoin JC, Strobl G. Recombination centers in Czochralski-grown p-Si. J Appl Phys. 1993;74(6):3944-3947. https:// doi.org/10.1063/1.354461.
- Zazoui M, Bourgoin JC, Deresmes D, Strobl G. Recombination centers in electron-irradiated Czochralski silicon solar cells. J Appl Phys. 1994;76(2):815-819. https://doi.org/10.1063/1.357755
- Ziegler JF, Ziegler MD, Biersack JP. SRIM—the stopping and range of ions in matter (2010). Nuclear Inst and Methods in Physics Research, B. 2010;268(11–12):1818-1823. https://doi.org/10.1016/j. nimb.2010.02.091
- Baur C, Meusel M, Dimroth F, Bett AW. Investigation of Ge component cells. IEEE 31st Photovoltaic Specialists Conference (PVSC) 2005:675-678. doi:https://doi.org/10.1109/PVSC.2005.1488221.
- Singh P, Ravindra NM. Temperature dependence of solar cell performance—an analysis. Sol Energy Mater Sol Cells. 2012;101(C:36-45. https://doi.org/10.1016/j.solmat.2012.02.019
- Boschini MJ, Rancoita PG, Tacconi M. SR-NIEL Calculator: screened relativistic (SR) treatment for calculating the displacement damage and nuclear stopping powers for electrons, protons, light- and heavyions in materials (Version 393). October 2017. http://www.sr-niel. org/.

- Bourgoin JC, Mooney PM, Poulin F. Defects and radiation effects in semiconductors. In: Inst. Phys. Conf. Ser. Hasiguti RR, ed. Vol 59. 1980:33.
- Zaidi MA, Zazoui M, Bourgoin JC. Defects in electron irradiated GaInP. J Appl Phys. 1993;73(11):7229-7231. https://doi.org/10.1063/ 1.354009
- Khan A, Khan A, Yamaguchi M, et al. Recombination centers in electron irradiated GalnP: application to the degradation of space solar cells. J Cryst Growth. 2000;210(1-3):264-267. https://doi.org/10.1016/s0022-0248(99)00693-4
- 32. Khan A, Yamaguchi M, Bourgoin JC, Bourgoin JC, Takamoto T. Thermal annealing study of 1 MeV electron-irradiation-induced defects in n+p InGaP diodes and solar cells. J Appl Phys. 2002;91(4):2391-2397. https://doi.org/10.1063/1.1433936
- 33. Khan A, Yamaguchi M, Dharmaso N, Bourgoin J, Ando K, Takamoto T. Deep level transient spectroscopy analysis of 10 MeV proton and 1 MeV Electron irradiation-induced defects in p-InGaP and InGaP-based solar cells. Jpn J Appl Phys. 2002;41(3):1241-1246. https://doi.org/ 10.1143/JJAP.41.1241
- Dharmarasu N, Yamaguchi M, Bourgoin JC, et al. Majority- and minority-carrier deep level traps in proton-irradiated n+/p-InGaP space solar cells. *Appl Phys Lett.* 2002;81(1):64-66. https://doi.org/10.1063/ 1.1491005
- Pons D, Bourgoin JC. Irradiation-induced defects in GaAs. J Phys C: Solid State Phys. 1985;18(20):3839-3871. https://doi.org/10.1088/ 0022-3719/18/20/012
- 36. Zaidi MA, Bourgoin JC, Maaref H. Poole-Frenkel-assisted emission from deep levels in electron-irradiated germanium. *Semicond Sci Technol.* 1989;4(9):739-742. https://doi.org/10.1088/0268-1242/4/ 9/006
- Vincent G, Chantre A, Bois D. Electric field effect on the thermal emission of traps in semiconductor junctions. J Appl Phys. 1979;50(8):5484-5487. https://doi.org/10.1063/1.326601
- Park S, Bourgoin JC, Cavani O, Khorenko V, Baur C, Boizot B. Origin of the degradation of triple junction solar cells at low temperature. Fernandez a, ed. E3S Web Conf 2017;16(1):04004-04004. doi: https://doi.org/10.1051/e3sconf/20171604004.